

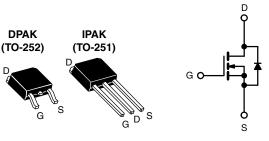
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Vishay Siliconix

COMPLIANT

HALOGEN

Power MOSFET



N-Channel	MOSEET

PRODUCT SUMMARY					
V _{DS} (V)	600				
R _{DS(on)} (Ω)	V _{GS} = 10 V 4.4				
Q _g (Max.) (nC)	18				
Q _{gs} (nC)	3.0				
Q _{gd} (nC)	8.9				
Configuration	Sin	gle			

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Surface-mount (IRFRC20, SiHFRC20)
- Straight lead (IRFUC20, SiHFUC20)
- Available in tape and reel
- · Fast switching
- · Ease of paralleling
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFUC, SiHFUC series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION							
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)		
Lead (Pb)-free and	SiHFRC20-GE3	SiHFRC20TRL-GE3	SiHFRC20TR-GE3	SiHFRC20TRR-GE3	SiHFUC20-GE3		
halogen-free	IRFRC20PbF-BE3	IRFRC20TRLPbF-BE3	IRFRC20TRPbF-BE3	IRFRC20TRRPbF-BE3	-		
Lead (Pb)-free	IRFRC20PbF	IRFRC20TRLPbF ^a	IRFRC20TRPbF ^a	IRFRC20TRRPbF ^a	IRFUC20PbF		

Note

See device orientation

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	V
Gate-source voltage			V_{GS}	± 20	7 v
Continuous drain current	V at 10 V	T _C = 25 °C	_	2.0	
Continuous drain current $V_{GS} \text{ at 10 V} \frac{T_C = 25 ^{\circ}\text{C}}{T_C = 100 ^{\circ}\text{C}}$			I _D	1.3	Α
Pulsed drain current ^a			I _{DM}	8.0	
Linear derating factor				0.33	W/°C
Linear derating factor (PCB mount) ^e				0.020	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Single pulse avalanche energy b			E _{AS}	74	mJ
Repetitive avalanche current a			I _{AR}	2.0	Α
Repetitive avalanche energy ^a			E _{AR}	4.2	mJ
Maximum power dissipation $T_C = 25 ^{\circ}C$			0	42	w
Maximum power dissipation (PCB mount) e T _A = 25 °C			P_{D}	2.5	vv
Peak diode recovery dV/dt ^c			dV/dt	3.0	V/ns
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) d	For	10 s		260	1 .0

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 37 \,^{\circ}\text{mH}$, $R_g = 25 \,^{\circ}\Omega$, $I_{AS} = 2.0 \,^{\circ}\text{A}$ (see fig. 12)
- c. $I_{SD} \le 2.0 \text{ A}$, $dI/dt \le 40 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_{J} \le 150 \,^{\circ}\text{C}$
- d. 1.6 mm from case
- e. When mounted on 1" square PCB (FR-4 or G-10 material)

S21-0818-Rev. F, 02-Aug-2021

IRFRC20, IRFUC20, SiHFRC20, SiHFUC20

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	=	110	
Maximum junction-to-ambient (PCB mount) ^a	R _{thJA}	-	-	50	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	-	3.0]

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				L	L		
Drain-source breakdown voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.88	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-source leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}		= 600 V, V _{GS} = 0 V V, V _{GS} = 0 V, T _J = 125 °C	-	-	100 500	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 1.2 A ^b	-	-	4.4	Ω
Forward transconductance	9fs		= 50 V, I _D = 1.2 A	1.4	-	-	S
Dynamic		_		I.		•	
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	350	-	
Output capacitance	C _{oss}		V _{DS} = - 25 V,	-	48	-	pF
Reverse transfer capacitance	C _{rss}	f = 1	f = 1.0 MHz, see fig. 5		8.6	-	
Total gate charge	Qq			-	-	18	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 2.0 \text{ A}, V_{DS} = 360 \text{ V},$		-	3.0	nC
Gate-drain charge	Q _{qd}	see fig. 6 and 13 ^b		-	-	8.9	1
Turn-on delay time	t _{d(on)}	V _{DD} = 300 V, I _D = 2.0 A,		-	10	-	
Rise time	t _r			-	23	-	1
Turn-off delay time	t _{d(off)}		$R_D = 135 \Omega$, see fig. 10^b	-	30	-	ns
Fall time	t _f	1		-	25	-	
Internal drain inductance	L _D	Between 6 mm (0.25	") from	-	4.5	-	الم
Internal source inductance	L _S		package and center of die contact		7.5	-	- nH
Drain-Source Body Diode Characteristic	es						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	2.0	A
Pulsed diode forward current ^a	I _{SM}			-	-	8.0	A
Body diode voltage	V _{SD}	T _J = 25 °C	$I_{S} = 2.0 \text{ A}, V_{GS} = 0 \text{ V}^{b}$	-	-	1.6	V
Body diode reverse recovery time	t _{rr}	T 05.00 !	0.0.4	-	290	580	ns
Body diode reverse recovery charge	Q _{rr}	$I_J = 25 ^{\circ}\text{C}, I_F$	$T_J = 25 ^{\circ}\text{C}, I_F = 2.0 \text{A}, \text{dI/dt} = 100 \text{A/} \mu \text{s}^{\text{b}}$		0.67	1.3	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)					L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

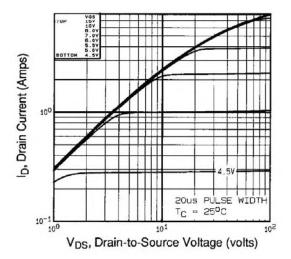


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

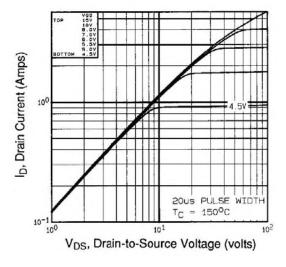


Fig. 1 - Typical Output Characteristics, T_C = 150 °C

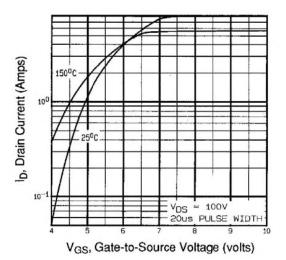


Fig. 2 - Typical Transfer Characteristics

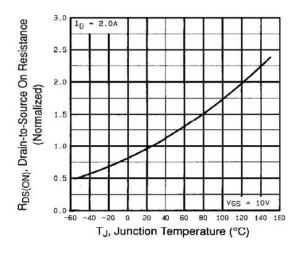


Fig. 3 - Normalized On-Resistance vs. Temperature

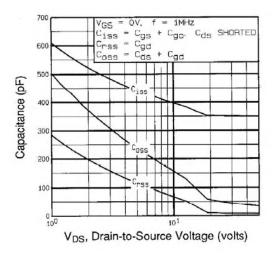


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage

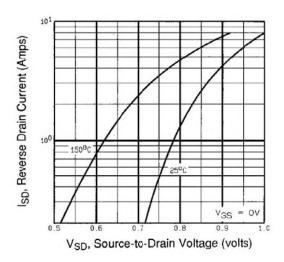


Fig. 6 - Typical Source-Drain Diode Forward Voltage

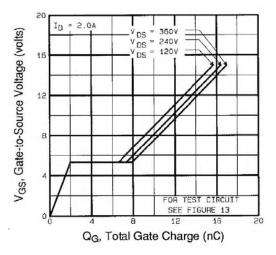


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage

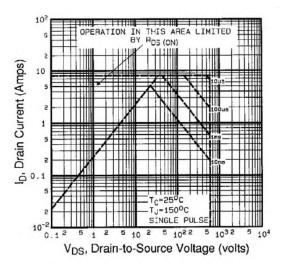


Fig. 7 - Maximum Safe Operating Area

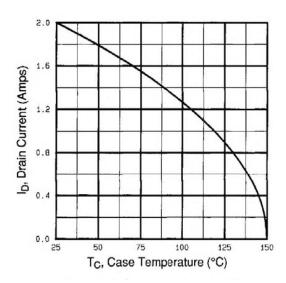


Fig. 8 - Maximum Drain Current vs. Case Temperature

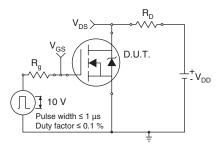


Fig. 10a - Switching Time Test Circuit

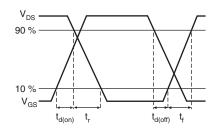


Fig. 10b - Switching Time Waveforms

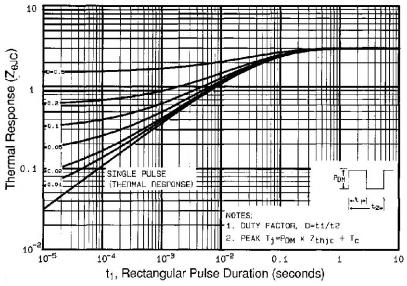


Fig. 9 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

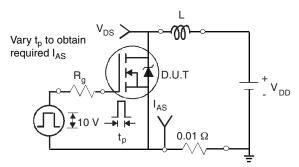


Fig. 12a - Unclamped Inductive Test Circuit

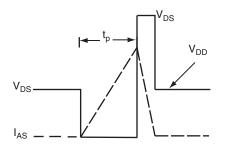


Fig. 12b - Unclamped Inductive Waveforms

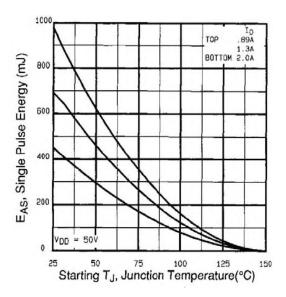


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

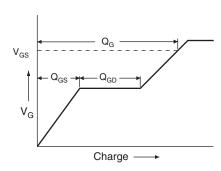


Fig. 13a - Basic Gate Charge Waveform

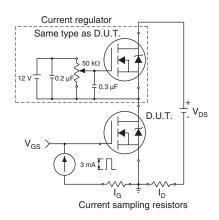
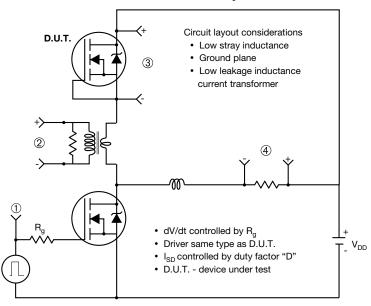


Fig. 13b - Gate Charge Test Circuit

Peak Diode Recovery dV/dt Test Circuit



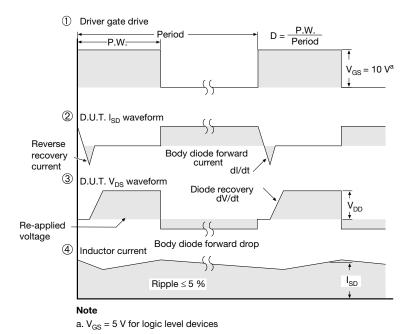


Fig. 10 - For N-Channel

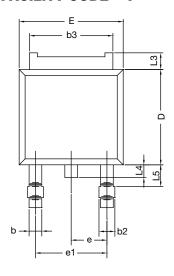
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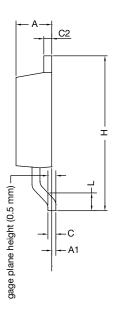


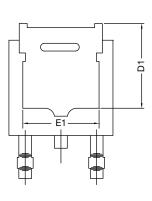
TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y

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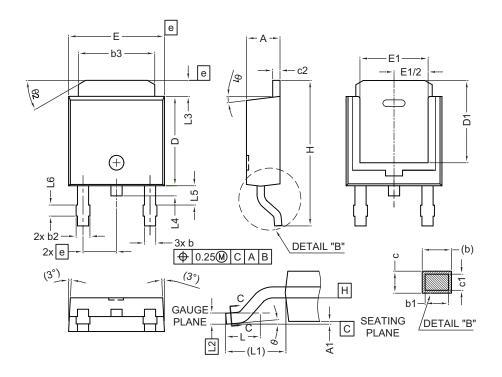
	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28	BSC	
e1	4.56	BSC	
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS			
DIM.	MIN.	MAX.		
Α	2.18	2.39		
A1	-	0.13		
b	0.65	0.89		
b1	0.64	0.79		
b2	0.76	1.13		
b3	4.95	5.46		
С	0.46	0.61		
c1	0.41	0.56		
c2	0.46	0.60		
D	5.97	6.22		
D1	5.21	=		
Е	6.35	6.73		
E1	4.32 -			
е	2.29 BSC			
Н	9.94	10.34		

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- · Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019

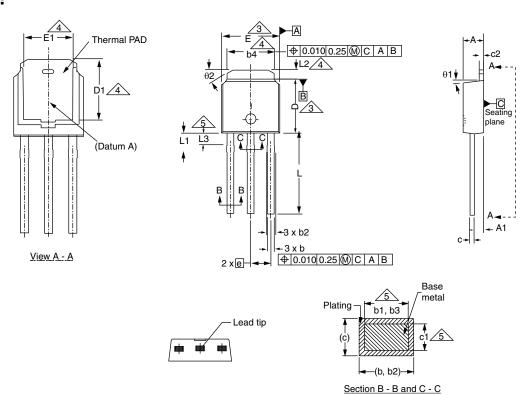
DWG: 5347

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Case Outline for TO-251AA (High Voltage)

OPTION 1:



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
Е	6.35	6.73	0.250	0.265
E1	4.32	=	0.170	=
е	2.29	2.29 BSC		BSC
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
θ1	0'	15'	0'	15'
θ2	25'	35'	25'	35'
	•		•	

ECN: E21-0682-Rev. C, 27-Dec-2021

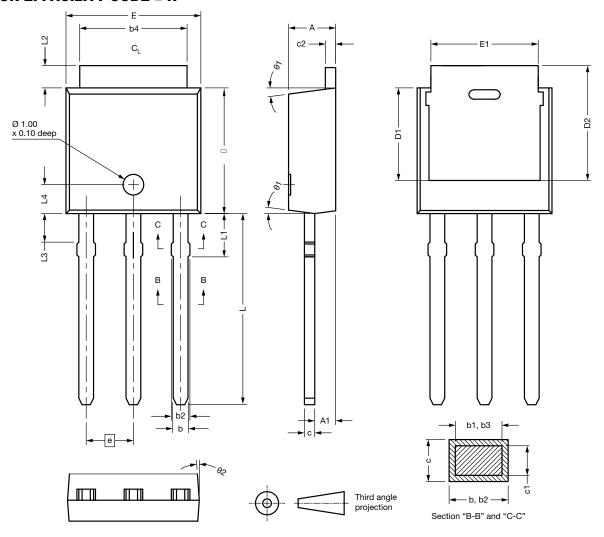
DWG: 5968

Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Dimension are shown in inches and millimeters
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- Thermal pad contour optional with dimensions b4, L2, E1 and D1
- Lead dimension uncontrolled in L3
- Dimension b1, b3 and c1 apply to base metal only
- Outline conforms to JEDEC® outline TO-251AA



OPTION 2: FACILITY CODE = N



DIM.	MIN.	NOM.	MAX.
Α	2.180	2.285	2.390
A1	0.890	1.015	1.140
b	0.640	0.765	0.890
b1	0.640	0.715	0.790
b2	0.760	0.950	1.140
b3	0.760	0.900	1.040
b4	4.950	5.205	5.460
С	0.460	-	0.610
c1	0.410	-	0.560
c2	0.460	-	0.610
D	5.970	6.095	6.220
D1	4.300	-	-

DIM.	MIN.	NOM.	MAX.
D2	5.380	-	-
E	6.350	6.540	6.730
E1	4.32	-	-
е	2.29 BSC		
L	8.890	9.270	9.650
L1	1.910	2.100	2.290
L2	0.890	1.080	1.270
L3	1.140	1.330	1.520
L4	1.300	1.400	1.500
θ1	0°	7.5°	15°
θ2	4°	-	-

ECN: E21-0682-Rev. C, 27-Dec-2021

DWG: 5968

- Dimensioning and tolerancing per ASME Y14.5M-1994
- All dimension are in millimeters, angles are in degrees
- Heat sink side flash is max. 0.8 mm



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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